



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Cc Wu	<b>Contact Title</b>	Product Compliance Engineer		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2017-05-17	<b>Contact Email</b>	cc.wu@te.com				
<b>Contact Phone Number</b>	86-2124071672								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	1734344-5	<b>Amount</b>	9704.0	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	D-Sub 15P, RCPT, R/A, Dip	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirements by application of the selected exemption(s)								
<b>ChinaRoHS-0508</b>	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0616</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Complex Article Description</b>	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Material	1	Rivet - Brass				1.0	690.0	mg	
Substance	2	Tin	Supplier	7440-31-5	0.5	1.0	3.45	mg	
Substance	2	Zinc	Supplier	7440-66-6	37.5	1.0	258.75	mg	
Substance	2	Aluminum	Supplier	7429-90-5	0.1	1.0	0.69	mg	
Substance	2	Copper	Supplier	7440-50-8	58.7	1.0	405.03	mg	
Substance	2	Iron	Supplier	7439-89-6	0.5	1.0	3.45	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	2.7	1.0	18.63	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Material	1	Terminals - Sn Plating				1.0	6.0	mg	
Substance	2	Sulphamidic-acid	Supplier	5329-14-6	0.02	1.0	0.0012	mg	
Substance	2	Tin	Supplier	7440-31-5	99.98	1.0	5.9988	mg	
Material	1	Housing - PA9T				1.0	4423.0	mg	
Substance	2	1,4-Benzenedicarboxylic acid, polymer with 2-methyl-1,8-octanediamine and 1,9-nonanediamine	Supplier	169284-22-4	43.0	1.0	1901.89	mg	
Substance	2	Glass, oxide, chemicals	Supplier	65997-17-3	33.0	1.0	1459.59	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	3.0	1.0	132.69	mg	
Substance	2	Benzene, ethenyl-, homopolymer, brominated	Supplier	88497-56-7	21.0	1.0	928.83	mg	
Material	1	Board lock - Sn Plating				1.0	24.0	mg	
Substance	2	Tin	Supplier	7440-31-5	99.98	1.0	23.9952	mg	

Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.02	1.0	0.0048	mg	
Material	1	Rivet - Ni Plating				1.0	30.0	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.02	1.0	0.0060	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.98	1.0	29.994	mg	
Material	1	Shell - Ni Plating				1.0	15.0	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.98	1.0	14.997	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.02	1.0	0.0030	mg	
Material	1	Terminals - Ni Plating				1.0	12.0	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.02	1.0	0.0024	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.98	1.0	11.9976	mg	
Material	1	Terminals - Au Plating				1.0	2.0	mg	
Substance	2	Gold	Supplier	7440-57-5	99.0	1.0	1.98	mg	
Substance	2	Cobalt	Supplier	7440-48-4	1.0	1.0	0.02	mg	
Material	1	Screwlock - Ni Plating				1.0	40.0	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.98	1.0	39.992	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.02	1.0	0.0080	mg	
Material	1	Terminals - C5210				1.0	489.0	mg	
Substance	2	Zinc	Supplier	7440-66-6	0.2	1.0	0.978	mg	
Substance	2	Copper	Supplier	7440-50-8	91.5	1.0	447.435	mg	
Substance	2	Tin	Supplier	7440-31-5	8.0	1.0	39.12	mg	
Substance	2	Iron	Supplier	7439-89-6	0.14	1.0	0.6846	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.15	1.0	0.7335	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.01	1.0	0.0489	mg	
Material	1	Board lock - Ni Plating				1.0	12.0	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.98	1.0	11.9976	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.02	1.0	0.0024	mg	
Material	1	Shell - SPCC				1.0	1450.0	mg	
Substance	2	Zinc	Supplier	7440-66-6	0.0099	1.0	0.14355	mg	
Substance	2	Manganese	Supplier	7439-96-5	0.2	1.0	2.9	mg	
Substance	2	Iron	Supplier	7439-89-6	99.75	1.0	1446.375	mg	
Substance	2	Carbon	Supplier	7440-44-0	0.04	1.0	0.58	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	1.0E-4	1.0	0.00145	mg	
Material	1	Board lock - C2680				1.0	668.0	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.01	1.0	0.0668	mg	
Substance	2	Zinc	Supplier	7440-66-6	33.94	1.0	226.7192	mg	
Substance	2	Iron	Supplier	7439-89-6	0.05	1.0	0.334	mg	
Substance	2	Copper	Supplier	7440-50-8	66.0	1.0	440.88	mg	
Material	1	Screwlock - Brass				1.0	1843.0	mg	
Substance	2	Copper	Supplier	7440-50-8	58.7	1.0	1081.841	mg	
Substance	2	Iron	Supplier	7439-89-6	0.5	1.0	9.215	mg	
Substance	2	Tin	Supplier	7440-31-5	0.5	1.0	9.215	mg	
Substance	2	Aluminum	Supplier	7429-90-5	0.1	1.0	1.843	mg	
Substance	2	Zinc	Supplier	7440-66-6	37.5	1.0	691.125	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	2.7	1.0	49.761	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight